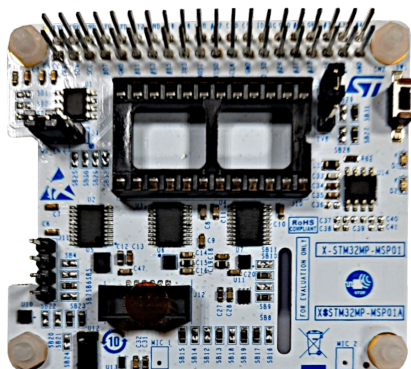


STM32MP expansion board for motion MEMS, environmental, ToF, and ALS sensor applications



Features

- Included sensors:
 - **ISM330DHCX**: 3-axis accelerometer and 3-axis gyroscope
 - **IIS2MDC**: 3-axis digital magnetometer (± 50 gauss)
 - **IIS2DLPC**: 3-axis accelerometer for industrial applications ($\pm 2/\pm 4/\pm 8/\pm 16$ g)
 - **STTS22H**: digital temperature sensor (-40 to $+125^{\circ}\text{C}$)
 - **LPS22HH**: nano pressure sensor (260 - 1260 hPa)
 - **VD6283TX**: ambient light sensor
 - **VL53L5CX**: Time-of-Flight (ToF) multizone ranging sensor
- Dynamic NFC/RFID tag
- Digital microphone
- Standard DIL 24 pin socket for adapter boards
- Compatible with **STM32MP157F-DK2** and Raspberry Pi

Description

The **X-STM32MP-MSP01** is a multisensor evaluation board that embeds motion MEMS, environmental, ambient light and Time-of-Flight sensors, a digital microphone, and an NFC tag. This board works with the STM32MPU discovery kit. It can be used with the **X-LINUX-MSP1** to read the sensors.

The **X-STM32MP-MSP01** main devices are the **ISM330DHCX** 3-axis accelerometer and gyroscope, the **IIS2MDC** 3-axis magnetometer, and the **LPS22HH** MEMS nano pressure sensor.

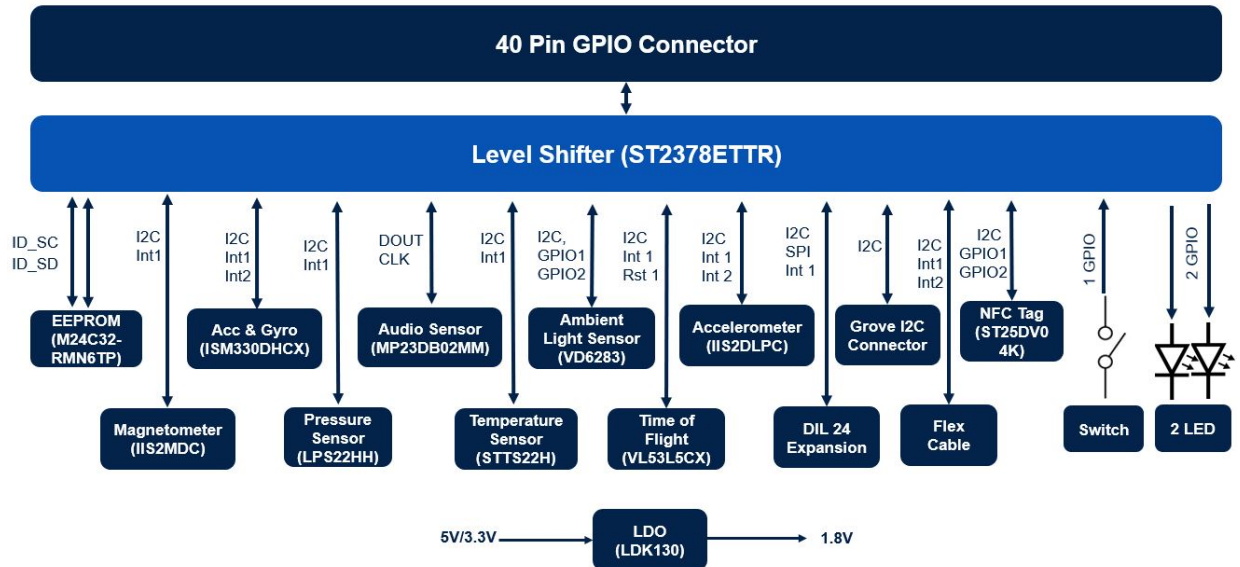
The board also includes the **STTS22H** digital temperature sensor, the **VD6283TX** ambient light sensor, the **IIS2DLPC** 3-axis accelerometer, the **VL53L5CX** multizone ranging sensor, and the **MP23DB02MM** digital MEMS microphone. The on-board dynamic NFC/RFID tag IC can work with a dual interface for the I²C, through a 13.56 MHz RFID reader, or via an NFC phone.

The **X-STM32MP-MSP01** interfaces with the **STM32MP1Dev** via a 40-pin GPIO connector pins using I²C, SPI, and general GPIO pins. It is compatible with **STM32MP157F-DK2** and a Raspberry Pi GPIO connector layout.

Product summary	
STM32MP expansion board for motion MEMS, environmental, ToF, and ALS sensor applications	X-STM32MP-MSP01
Discovery kit with STM32MP157F MPU	STM32MP157F-DK2
iNEMO inertial module with Machine Learning Core	ISM330DHCXTR
STM32 MPU OpenSTLinux software expansion package for X-STM32MP-MSP01	X-LINUX-MSP1
Applications	Industrial Robots/ Virtual Augmented Reality/Wearable

1 Block diagram

Figure 1. X-STM32MP-MSP01 block diagram



2

Figure 2. X-STM32MP-MSP01 circuit schematic (1 of 11)

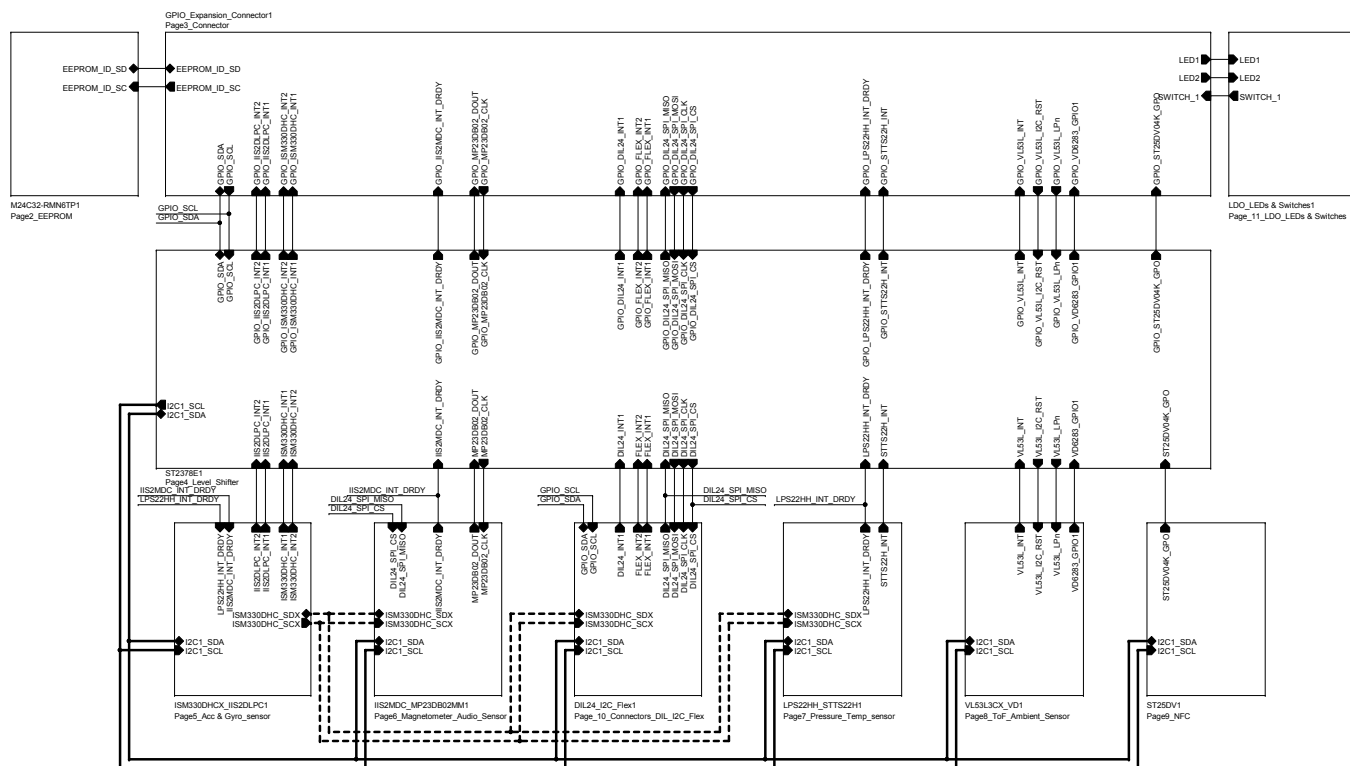


Figure 3. X-STM32MP-MSP01 circuit schematic (2 of 11)

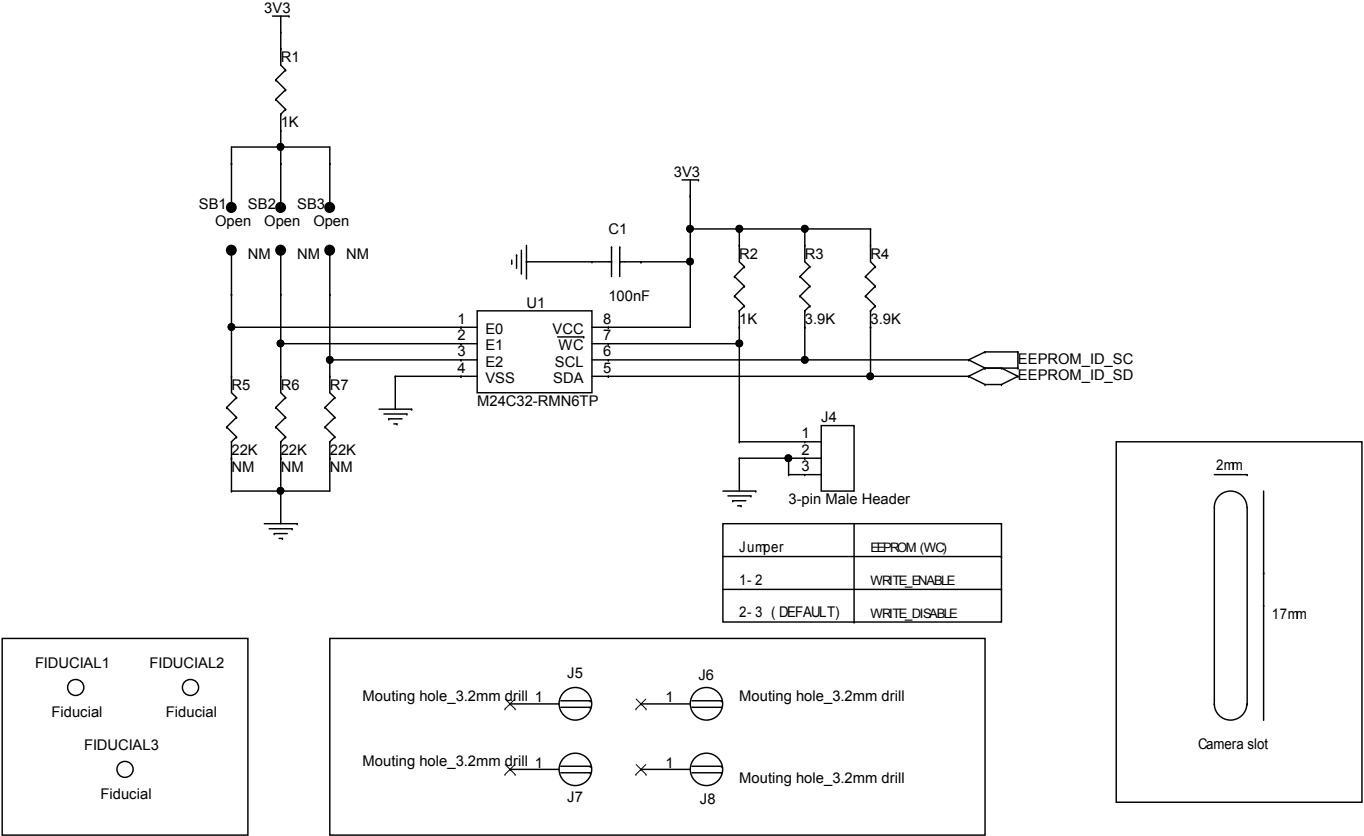


Figure 4. X-STM32MP-MSP01 circuit schematic (3 of 11)

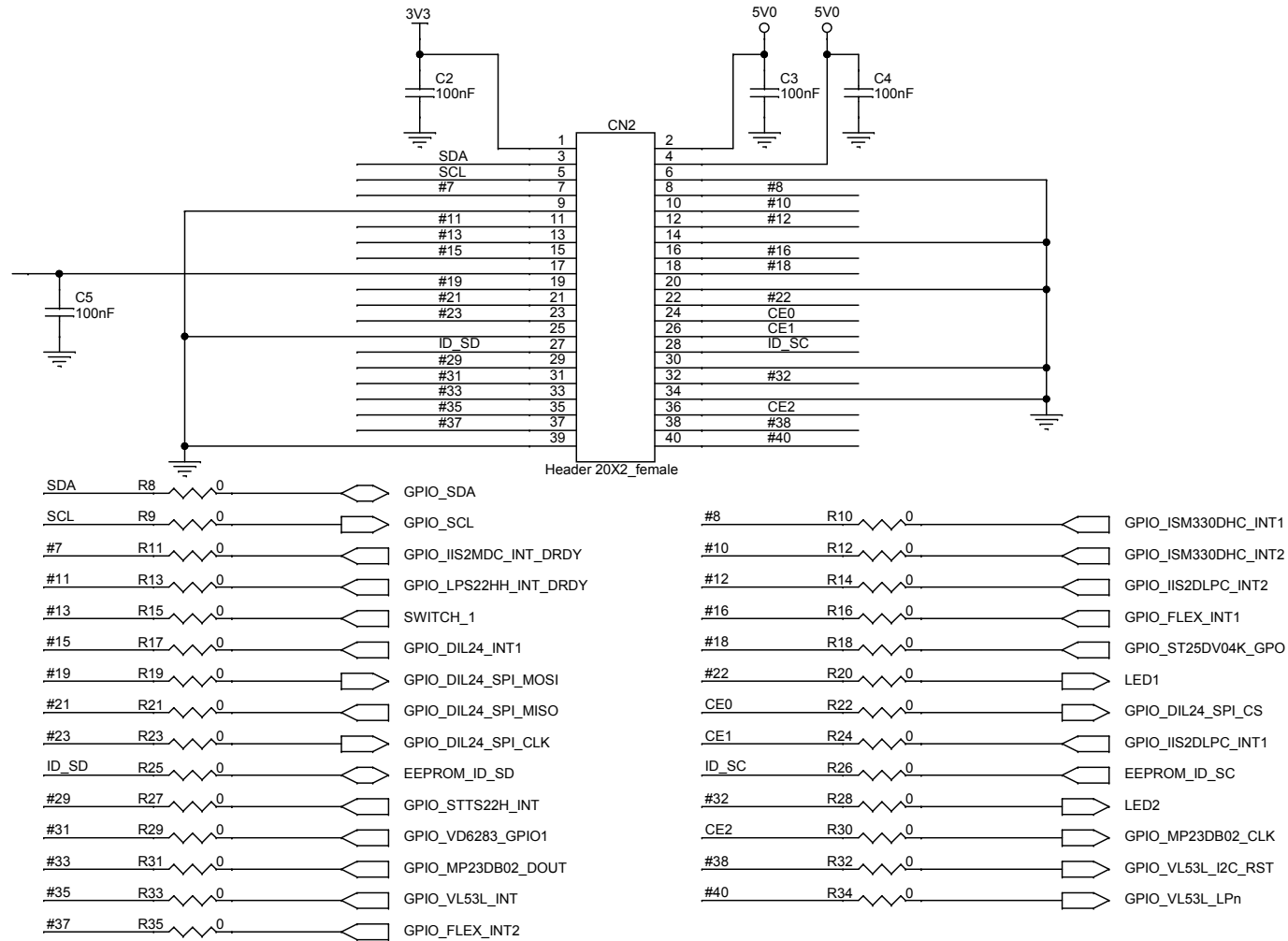


Figure 5. X-STM32MP-MSP01 circuit schematic (4 of 11)

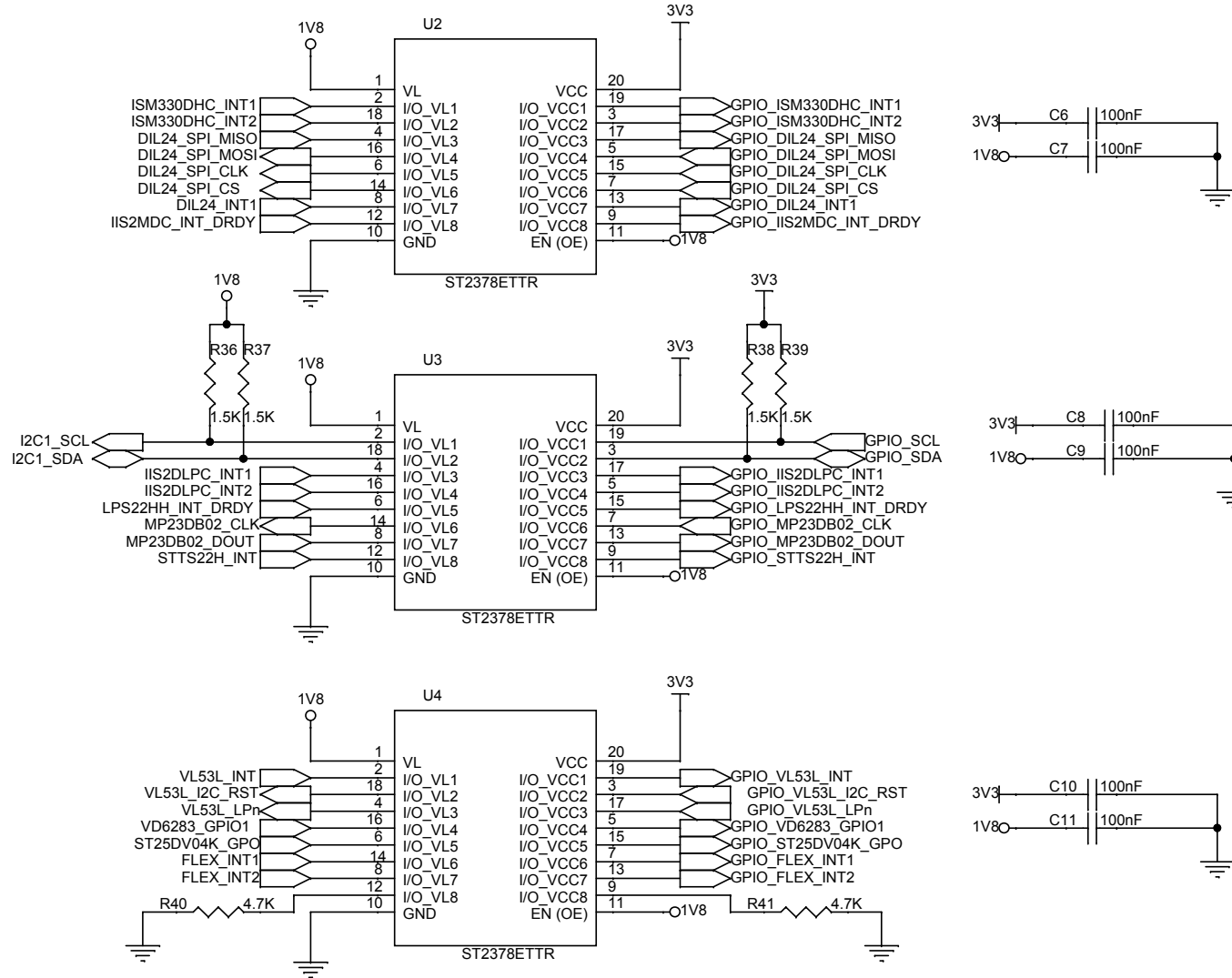


Figure 6. X-STM32MP-MSP01 circuit schematic (5 of 11)

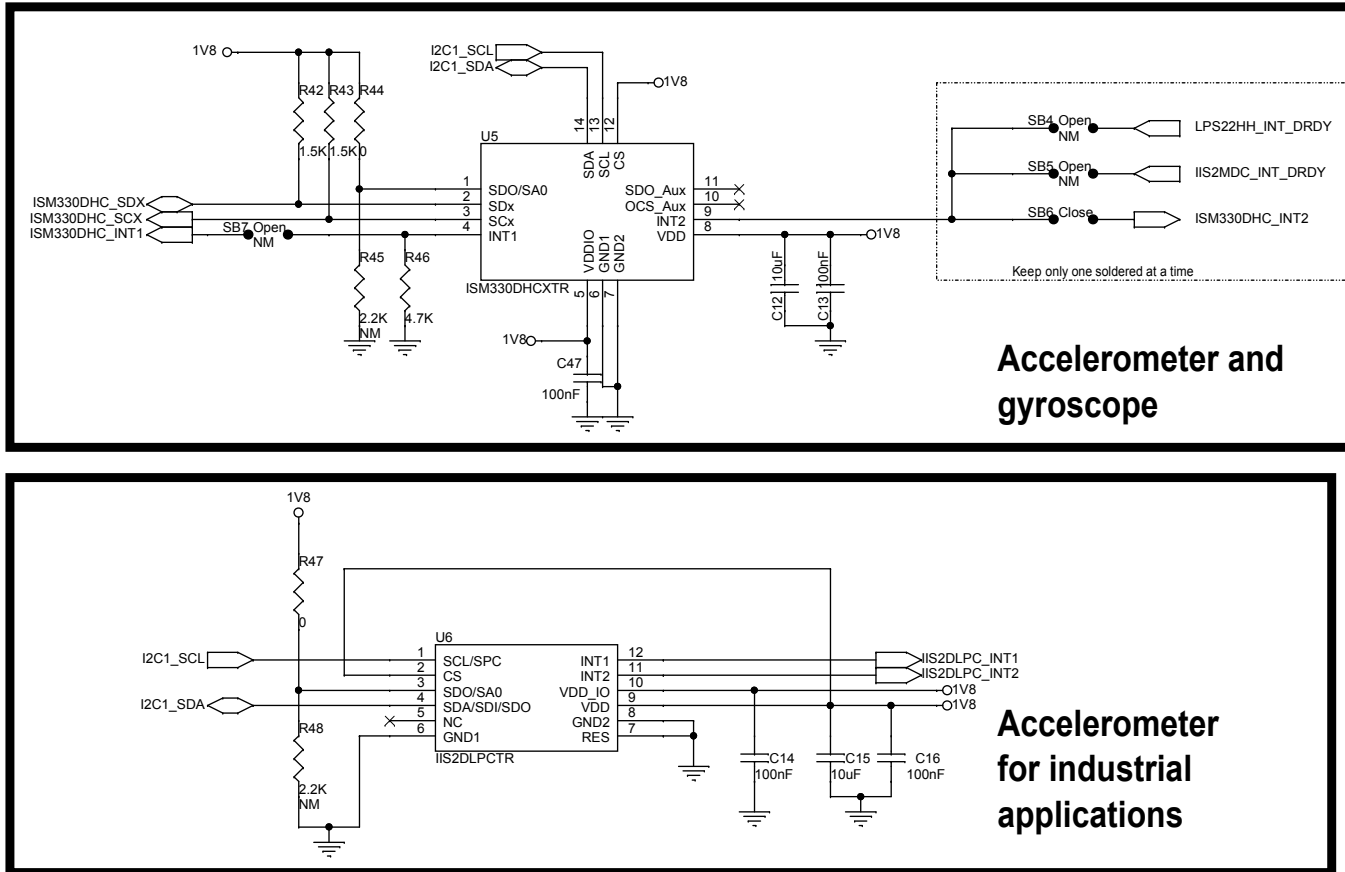


Figure 7. X-STM32MP-MSP01 circuit schematic (6 of 11)

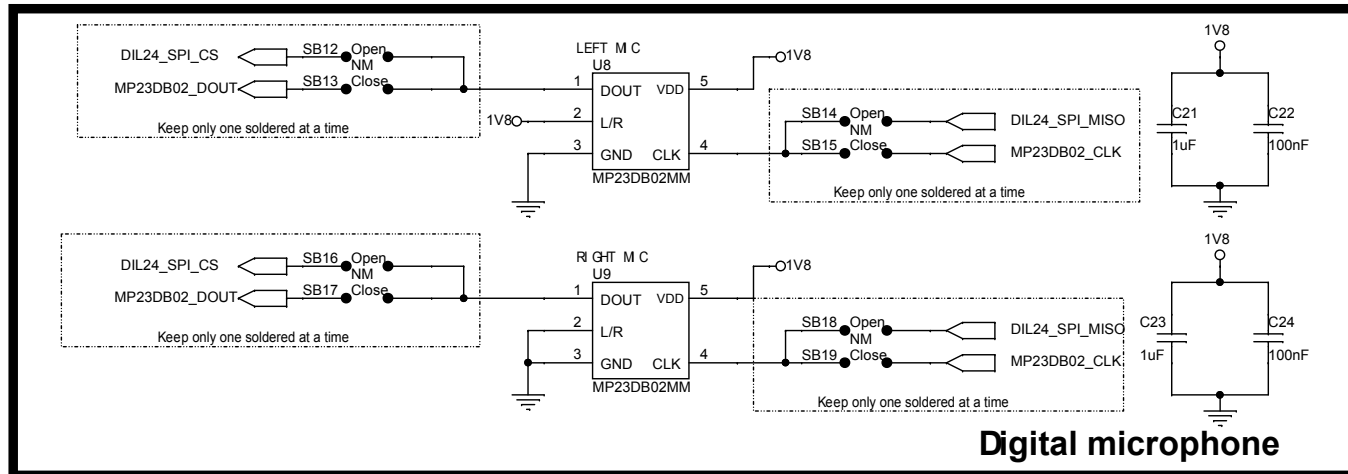
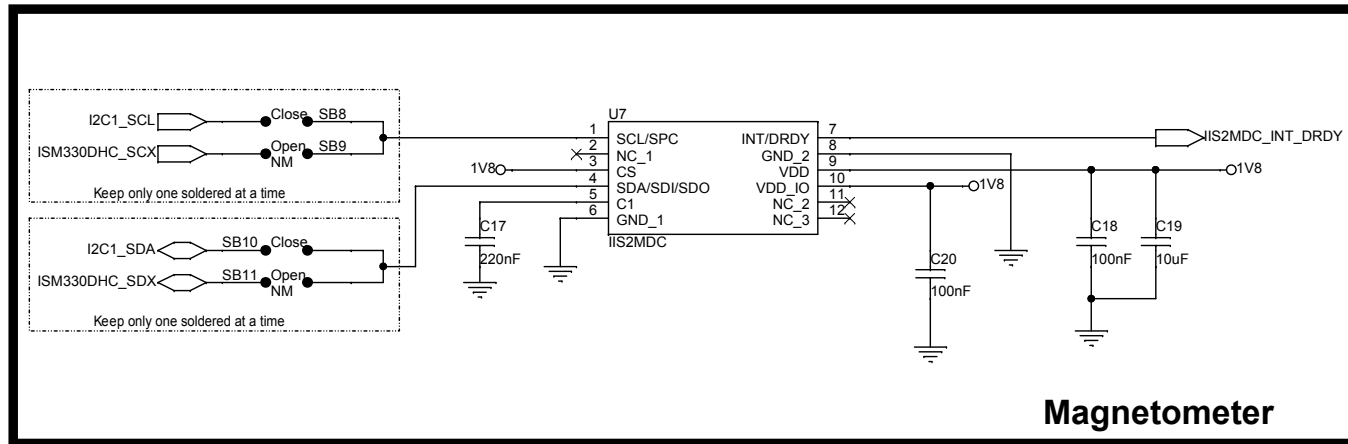


Figure 8. X-STM32MP-MSP01 circuit schematic (7 of 11)

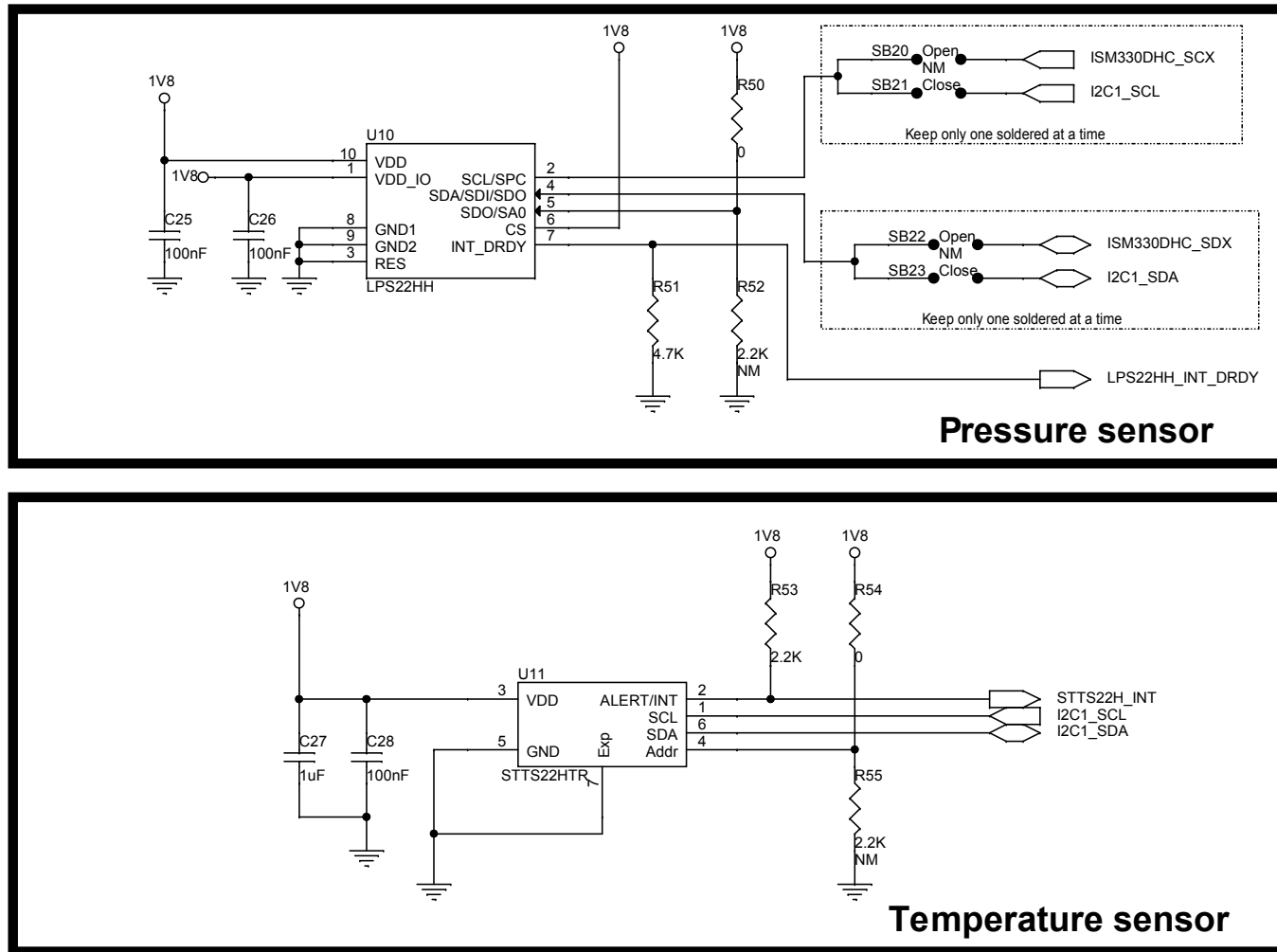


Figure 9. X-STM32MP-MSP01 circuit schematic (8 of 11)

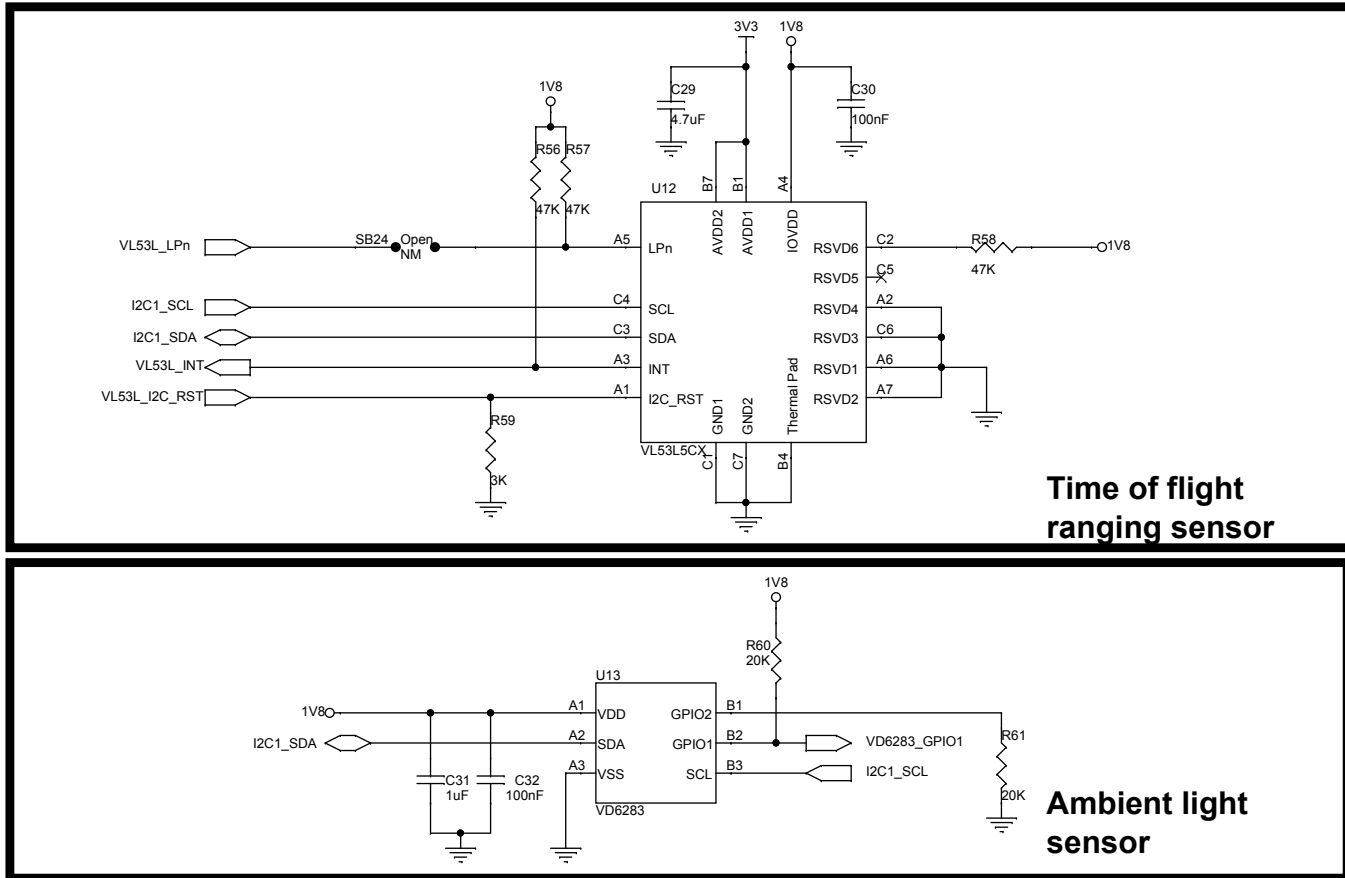


Figure 10. X-STM32MP-MSP01 circuit schematic (9 of 11)

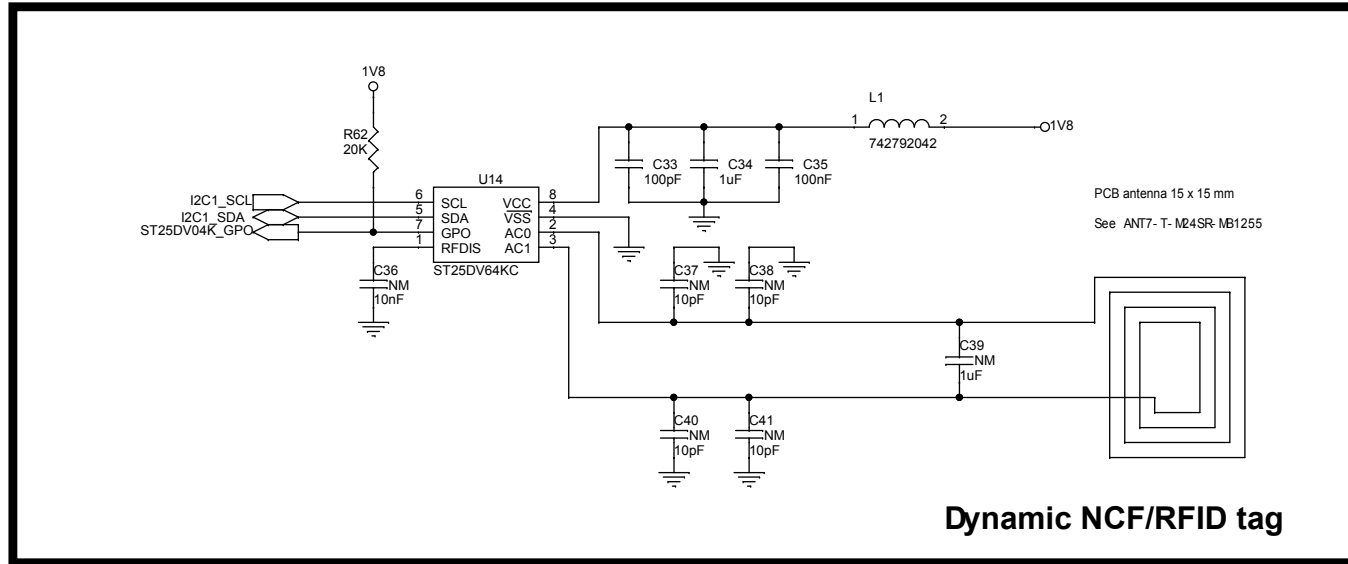


Figure 11. X-STM32MP-MSP01 circuit schematic (10 of 11)

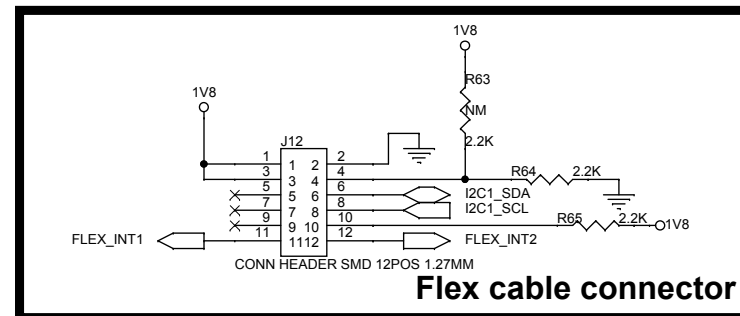
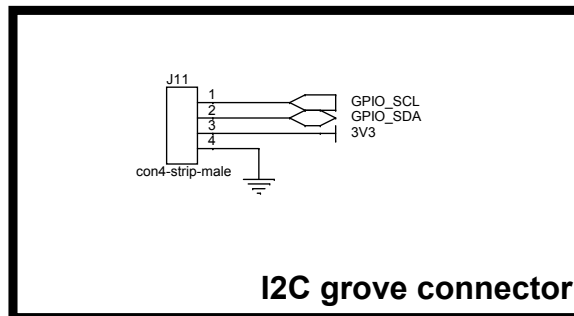
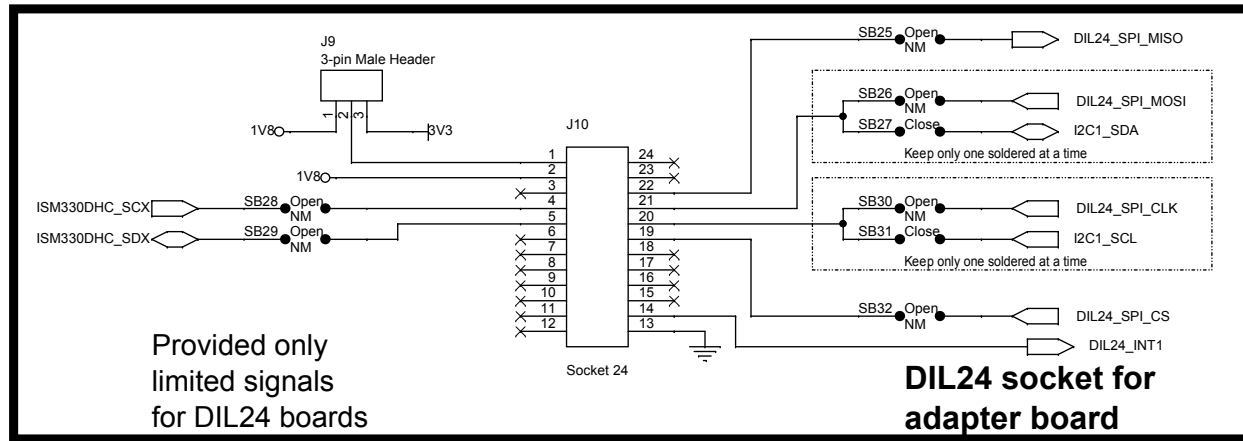
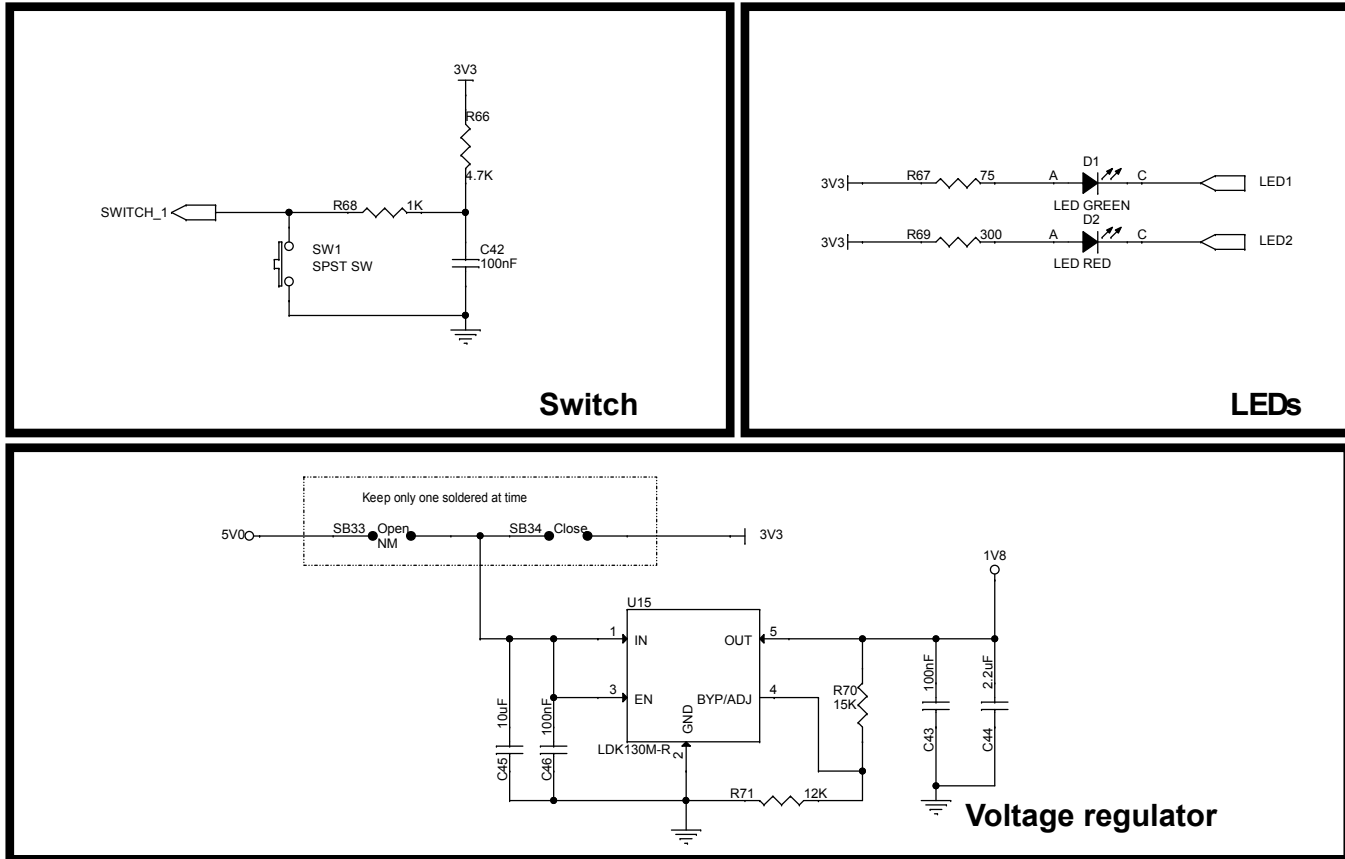


Figure 12. X-STM32MP-MSP01 circuit schematic (11 of 11)



3 X-STM32MP-MSP01 versions

Table 1. X-STM32MP-MSP01 versions

PCB version	Schematic diagrams	Bill of materials
X\$STM32MP-MSP01A ⁽¹⁾	X\$STM32MP-MSP01A schematic diagrams	X\$STM32MP-MSP01A bill of materials

1. This code identifies the X-STM32MP-MSP01 expansion board first version. It is printed on the board PCB.

Revision history

Table 2. Document revision history

Date	Revision	Changes
11-Oct-2022	1	Initial release.

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